Haichao Zhu - CV

Microsoft Research Asia,

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<www.haichaozhu.com>

**Education**

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| **Beijing University of Posts and Telecommunications** | 08/2012 - 06/2017 |
| Bachelor |  |
| Telecommunication Engineering |  |

**Work**

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| **Hasso Plattner Institut,** HCI Lab | 04/2016 - 10/2016 |
| Research Intern |  |
| Advisor: [Patrick Baudisch](http://www.patrickbaudisch.com/) |  |
| **Microsoft Research Asia,** HCI Group | 08/2015 – 04/2016 |
| Research intern |  |
| Advisor: [Fukumoto Masaaki](https://www.microsoft.com/en-us/research/people/fukumoto/) |  |
| **Tsinghua University,** Institute of HCI and Media Integration | 07/2014 – 06/2015 |
| Research intern |  |
| Advisor: [Yuanchun Shi](http://media.cs.tsinghua.edu.cn/~pervasive/shiyc/) |  |
| **Beijing University of Posts and Telecommunications,** Innovation Lab | 08/2013 – 08/2015 |
| Student |  |
| Advisor: Wenshen Sun, Li Guo, Chenwen Cheng, Yitong Liu |  |

**Awards and Honors**

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| 1st Prize in US-China Maker Contest |
| 1st Prize in International Microsoft Imagine Cup in China |
| 1st Prize in National LabVIEW Virtual Instrument Contest |
| 1st Prize in National Collegiate Smart Car Contest |
| 1st Prize in Innovation Festival in BUPT |
| 2nd Prize in Intel Cup Undergraduate Electronic Invitational Contest |
| 2nd Prize in Beijing Electronic Design Contest |
| 3rd Prize in International Mathematical Contest in Modeling |
| 3rd Prize in Xiaomi Innovation maker contest |
| Scholarships in Beijing University of Posts and Telecommunications (once a year for 4 years) |

**Community Activities**

**Attended Conference**

ACM CHI 2015, ACM CHI 2016

**Student Volunteer**

ACM UIST 2016